

PS04P30SA 30V Single Channel PMOSEFT

Revision : 1.0

Update Date : Apr. 2011

ProsPower Microelectronics Co., Ltd

1. General Description

The PS04P30SA uses advanced trench technology and design to provide excellent Rds(on) with low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. Standard Product PS04P30SA is Pb-free (meets ROHS & Sony 259 specifications). It is offered in the very popular SOT23 package

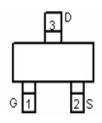
2. Applications

- PWM applications
- Load switch
- Power management

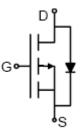
3. Features

- Vds=-30V, Id=-4.2A
- Rds(on)=62mohm (Vgs=-4.5V)
- Rds(on)=72mohm (Vgs=-2.5V)
- High Power and current handing capability
- Low capacitance minimizes driver loss
- Optimized gate charge minimizes switching loss

Pin Configuration



SOT23



Schematic

Pin Descriptions

Pin Name	Symbol	Function
Gate(1)	G	Device Gate terminal
Drain(3)	D	Device drain terminal
Source(2)	S	Device source terminal



Absolute Maximum Ratings

Stress greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These stress ratings only, and functional operation of the device at these or any conditions beyond those indicated under recommended Operating Conditions is not implied. Exposure to "Absolute Maximum Rating" for extended periods may affect device reliability. Use of standard ESD handling precautions is required.

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V _{DS}	-30	V
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current	I _D	-4.2	Α
Pulsed Drain Current (Note 1)	I _{DM}	-30	Α
Power Dissipation T _C =25°C	PD	1.4	W
Junction and Storage Temperature Range	T _J , T _{STG}	-65 to 150	°C

Thermal Characteristics

Parameter	Symbol	Тур.	Units
Maximum Junction-to-Ambient (Note2)	$R_{\theta JA}$	125	°C/W

Electrical Specifications

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
STATIC PARAMETERS							
Drain-Source Breakdown Voltage	BVDss	I _D =-250uA, V _{GS} =0V		-30	-35		V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V, V _{GS} =0V				-0.1	uA
Gate-Body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V				±0.1	μA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA		-0.7	-1.0	-1.3	V
Otatia Basia Osama Osa Basiatana	RDS(ON)	V _{GS} =-4.5V, I _D =-4A			62	65	
Static Drain-Source On-Resistance		V _{GS} =-2.5V, I _D =-2.5A			72	90	mΩ
Maximum Body-Diode Continuous Current	ls				-2.2	Α	
Diode Forward Voltage	V _{SD}	I _S =-1A, V _{GS} =0V			-0.8	-1.0	٧
Forward Transconductance	g fs	V _{DS} =-5V, I _D =-2.8A		7	11		S
DYNAMIC PARAMETERS							
Input Capacitance	Ciss	V _{GS} =0V, V _{DS} =-15V,			954		pF
Output Capacitance	Coss	f=1MHz			115		pF
Reverse Transfer Capacitance	C _{rss}				77		pF
SWITCHING PARAMETERS							
Total Gate Charge	Qg	V _{GS} =-4.5V, V _{DD} =-15V,			9.5		nC

ProsPower Microelectronics Co., Ltd



Gate Source Charge	Qgs	I _D =-4A (Note 3)	2	nC
Gate Drain Charge	Qgd		3	nC
Turn-On Delay Time	t _{D(on)}	1 44)/ 45)/	6.5	ns
Turn-On Rise Time	tr	I _D =-1A, V _{DD} =-15V,	3.5	ns
Turn-Off Delay Time	t _{D(off)}	V_{GEN} =-10V, R_L =3.6 Ω	38	ns
Turn-Off Fall Time	t _f	R _G =6Ω(Note 3)	12	ns

Notes

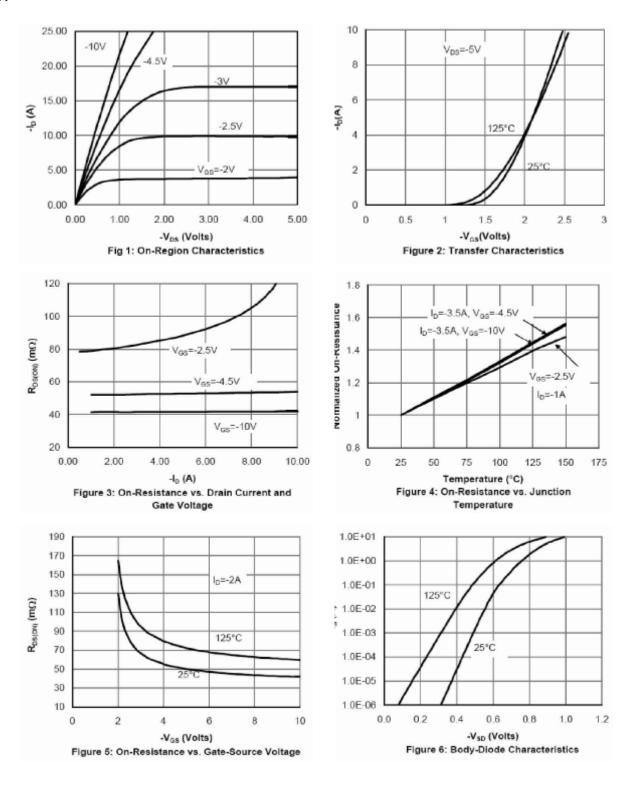
- 1. Pulse width limited by max. junction temperature
- 2. Surface mounted on 1 in 2 copper pad of FR4 board, t <= 5sec; 180 $^{\circ}$ C/W when mounted on min. copper pad.
- 3. Pulse Width <= 300us, Duty Cycle <=2%



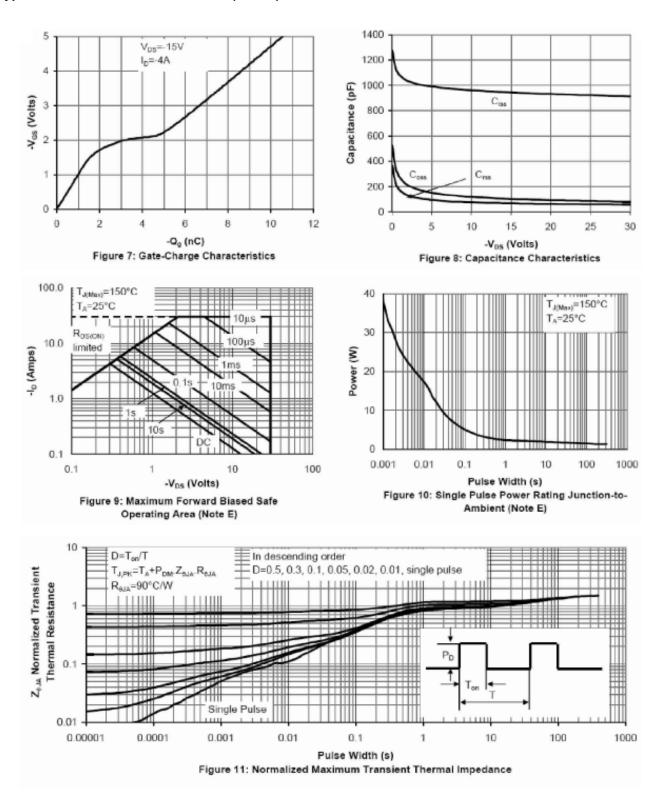
ProsPower

30V Single Channel PMOSFET

Typical Performance Characteristics

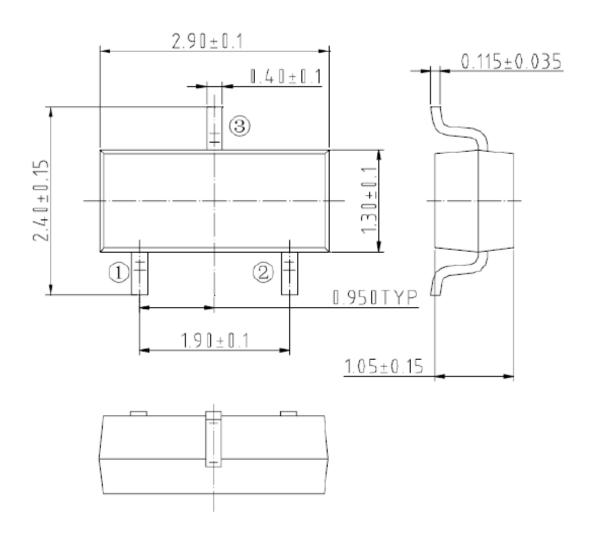


Typical Performance Characteristics (contd.)





Package Dimensions SOT23





Ordering Information

Device	Operating T _j	PKG Type	Wrap	Order Number
PS04P30SA	-65C° ≤150C°	SOT23	T&R	PS04P30SA-S2-TL

Note: Lead Free and RoHS compliant.

Warranty and Use

PROSPOWER MICROELECTRONICS MAKES NO WARRANTY, REPRESENTATION OR GUARANTEE, EXPRESS OR IMPLIED, REGARDING THE SUITABILITY OF ITS PRODUCTS FOR ANY PARTICULAR PURPOSE, NOR THAT THE USE OF ITS PRODUCTS WILL NOT INFRINGE ITS INTELLECTUAL PROPERTY RIGHTS OR THE RIGHTS OF THIRD PARTIES WITH RESPECT TO ANY PARTICULAR USE OR APPLICATION AND SPECIFICALLY DISCLAIMS ANY AND ALL LIABILITY ARISING OUT OF ANY SUCH USE OR APPLICATION, INCLUDING BUT NOT LIMITED TO, CONSEQUENTIAL OR INCIDENTAL DAMAGES.

ProsPower Microelectronics products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the ProsPower Microelectronics product could create a situation where personal injury or death may occur.

ProsPower Microelectronics reserves the right to make changes to or discontinue any product or service described herein without notice. Products with data sheets labeled "Advance Information" or "Preliminary" and other products described herein may not be in production or offered for sale.

ProsPower Microelectronics advises customers to obtain the current version of the relevant product information before placing orders. Circuit diagrams illustrate typical semiconductor applications and may not be complete.